

WP1533BQ/ID

4.7mm Single-Level Circuit Board Indicator



DESCRIPTION

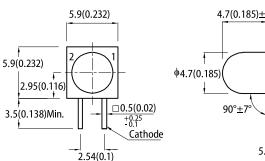
 The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode

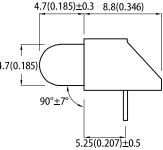
FEATURES

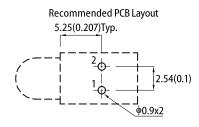
- · Pre-trimmed leads for pc mounting
- Black case enhances contrast ratio
- · High reliability life measured in years
- Housing UL rating: 94V-0
- Housing material: Type 66 nylon
- RoHS compliant

APPLICATIONS

- Status indicator
- Illuminator
- Signage applications
- · Decorative and entertainment lighting
- Commercial and residential architectural lighting







Notes.

All dimensions are in millimeters (inches).
 Tolerance is ±0.25(0.01") unless otherwise noted.

PACKAGE DIMENSIONS

- Lead spacing is measured where the leads emerge from the package.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice

SELECTION GUIDE

Part Number	Emitting Color	Lens Type	lv (mcd) @ 10mA ^[2]		Viewing Angle ^[1]	
	(Material)	Lens Type	Min.	Тур.	201/2	
WP1533BQ/ID	High Efficiency Red (GaAsP/GaP)	Red Diffused	25	70	20%	
			*12	*30	30°	

Notes

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
 * Luminous intensity value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Falameter	Symbol	Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission I_F = 10mA	λ_{peak}	High Efficiency Red	627	-	nm
Dominant Wavelength I _F = 10mA	λ_{dom} ^[1]	High Efficiency Red	617	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 10mA	Δλ	High Efficiency Red	45	-	nm
Capacitance	С	High Efficiency Red	15	-	pF
Forward Voltage I_F = 10mA	$V_{F}^{[2]}$	High Efficiency Red	1.9	2.3	V
Reverse Current (V _R = 5V)	I _R	High Efficiency Red	-	10	μA

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

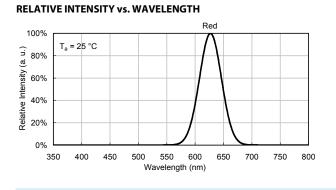
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	P _D	75	mW	
Reverse Voltage	V _R	5	V	
Junction Temperature	Tj	125	°C	
Operating Temperature	T _{op}	-40 To +85	°C	
Storage Temperature	T _{stg}	-40 To +85	°C	
DC Forward Current	I _F	30	mA	
Peak Forward Current	I _{FM} ^[1]	160	mA	
Electrostatic Discharge Threshold (HBM)	-	8000	V	
Lead Solder Temperature [2]		260°C For 3 Seconds		
Lead Solder Temperature ^[3]		260°C For 5 Seconds		

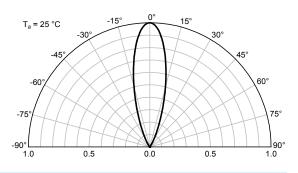
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. 2mm below package base. 3. 5mm below package base. 4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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TECHNICAL DATA



SPATIAL DISTRIBUTION



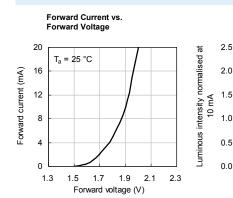
HIGH EFFICIENCY RED

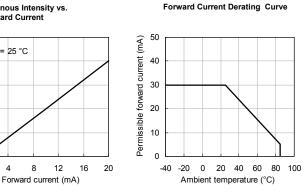
Luminous Intensity vs.

Forward Current

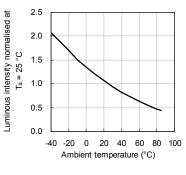
T_a = 25 °C

0 4 8 12

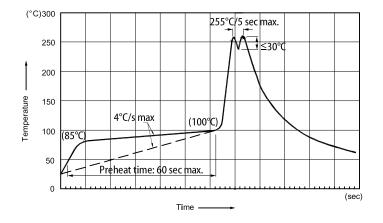








RECOMMENDED WAVE SOLDERING PROFILE



Notes

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260 $^\circ\mathrm{C}$

- Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
 Do not apply stress to the epoxy resin while the temperature is above 85°C.
 Fixtures should not incur stress on the component when mounting and during soldering process. SAC 305 solder alloy is recommended.
 No more than one wave soldering pass.

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PACKING & LABEL SPECIFICATIONS

